

## Application Data Sheet

### **Inventor Information**

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Postal or Zip Code:	
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### **Correspondence Information**

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### **Application Information**

Title Line One:	SEMICONDUCTOR LASER PACKAGE AND
Title Line Two:	FABRICATION METHOD THEREOF
Total Drawing Sheets:	6
Formal Drawings?:	Yes
Application Type:	Utility

Docket Number: 245402004300

**Representative Information**

Representative Customer Number: 25226

**Continuity Information**

This application is a:

> Application One:

Filing Date:

which is a:

>>Application Two:

Filing Date:

which is a:

>>>Application Three:

Filing Date:

**Prior Foreign Applications**

Foreign Application One: 2001-025259  
Filing Date: February 1, 2001  
Country: Japan  
Priority Claimed: Yes